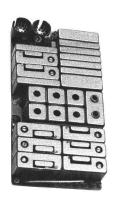
MASTR[®] Personal Series PROGRESS LINE

PE MODELS
138-150.8 MHz, RECEIVER MODELS 4ER59B10 & 4ER59B12



SPECIFICATIONS *

Type Number

Audio Output (EIA)

Channel Spacing

Sensitivity
12-dB SINAD (EIA Method)
20-dB Quieting Method

Selectivity
EIA Two-Signal
20-dB Quieting Method

Spurious Response

Intermodulation (EIA)

Audio Response

Modulation Acceptance

Squelch Sensitivity Critical Squelch Maximum Squelch ER-59-B

500~milliwatts at less than 5% distortion

30 kHz

 $\begin{array}{c} 0.25 \ \mu V \\ 0.35 \ \mu V \end{array}$

-75 dB at ± 30 kHz -110 dB at ± 30 kHz

-70 dB

-60 dB

Within +2 and -10 dB of a standard 6-dB per octave de-emphasis curve from 300 to 3000 Hz (1000 Hz reference)

 $\pm 7.5 \text{ kHz}$

 $0.15~\mu V$ Greater than 20-dB Quieting

MAXIMUM FREQUENCY SPREAD (MHz)

FREQUENCY RANGE	FULL Performance	1 dB Degradation in Sensitivity
138-145 MHz	0.55 MHz	1.1 MHz
145-150.8 MHz	0.58 MHz	1.16 MHz

^{*}These specifications are intended primarily for the use of the serviceman. Refer to the appropriate Specification Sheet for the complete specifications.

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— WARNING —

No one should be permitted to handle any portion of the equipment that is supplied with high voltage; or to connect any external apparatus to the units while the units are supplied with power. KEEP AWAY FROM LIVE CIRCUITS.

DESCRIPTION

Receiver Models 4ER59B10 and 4ER59B12 are single conversion, superheterodyne FM receivers for one through eight frequency operation on the 138-150.8 MHz bands. The complete receiver mounts on a single printed wiring board, and utilizes both discrete components and Integrated Circuit modules.

The application of each model receiver is shown in the following chart:

Model No.	Freq. Range	Number of Freq.	Tone Option
4ER59B10	138-150.8 MHz	3 to 8	
4ER59B12	138-150.8 MHz	3 to 8	Channel Guard

References to symbol numbers mentioned in the following test are found on the Schematic Diagram, Outline Diagram and Parts List (see Table of Contents). The typical circuit diagrams used in the text are representative of the circuits used in the Integrated Circuit modules. A block diagram of the receiver is shown in Figure 1.

Supply voltage for the receiver includes a continuous regulated 5.4 Volts for the compensator module, a continuous 7.5 Volts for the squelch module, and a switched 7.5 Volts for the remaining receiver stages.

CIRCUIT ANALYSIS

OSCILLATOR MODULES

Oscillator Model 4EG28Al5 consists of a crystal-controlled Colpitts oscillator similar to the Oscillator module used in the transmitter (see Figure 2). The entire oscillator is contained in a metal can with the receiver operating frequency printed on the top. The crystal frequency ranges from 14.75 to 16.87 MHz, and the crystal frequency is multiplied 8 times.

The oscillator frequency is temperature compensated to provide instant frequency compensation, with a frequency stability of $\pm .0002\%$ from 0°C to +55°C and $\pm .0005\%$ from -30°C to +60°C. The temperature compensation network is contained in Compensator Module A313.

In multi-frequency receivers, additional oscillator modules are mounted on the receiver board. The single-frequency supply

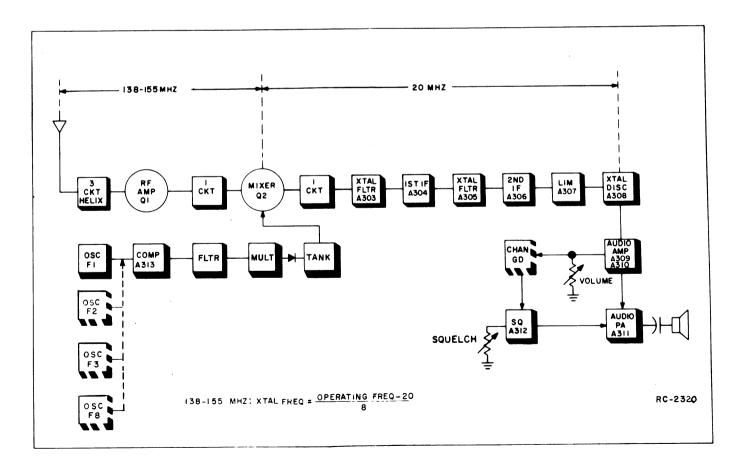


Figure 1 - Receiver Block Diagram

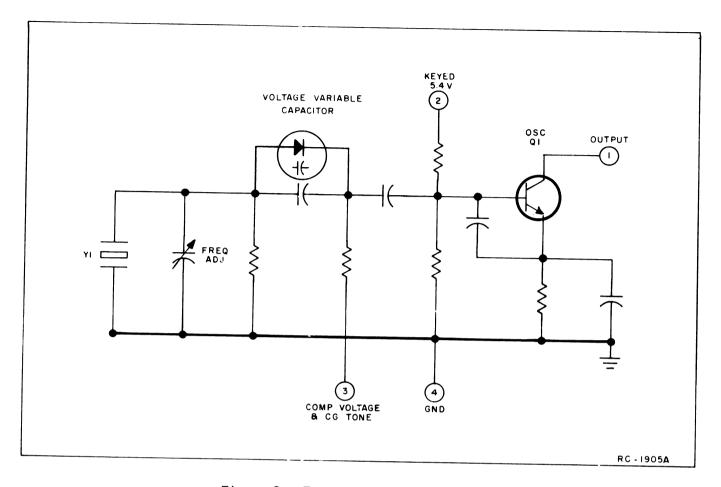


Figure 2 - Typical Oscillator Circuit

jumper is removed, and the proper frequency is selected by connecting the 5.4 Volts to the selected oscillator module through frequency selector switch S1 on the control unit.

- NOTE -

All oscillator modules are individually compensated at the factory and cannot be repaired in the field. Any attempt to remove the oscillator cover will void the warranty.

COMPENSATOR A313

Compensator module A313 contains a buffer-amplifier stage, and the temperature compensation network for the oscillator similar to the Compensator used in the transmitter (see Figure 3).

RF from the oscillator is coupled through a DC blocking capacitor to the base of Ql. The output of Ql connects to multiplier coil Ll on the Multiplier assembly.

In the compensation network, the regulated 5.4 Volts at Pin 2 is applied to a thermistor-compensated voltage divider.

The output at Pin 3 (2.35 Volts measured with a VTVM) is applied to Pin 3 and to the varactor in the Oscillator module. At temperatures below -10°C, the compensated voltage increases to maintain the proper voltage on the oscillator voltage-variable capacitor.

- SERVICE NOTE -

An abnormally low VTVM reading (or no reading) at Pin 3 may indicate a short or leakage path in the oscillator. This can be checked by unsoldering Pin 3, raising it off of the printed board and taking another reading. If this reading is normal, the problem is in the Oscillator module. If the reading remains low (or zero), the problem is in the Compensator.

FRONT END A301

The receiver Front End consists of three tuned helical resonators, an RF amplifier and Mixer stage as well as the Filter, Multiplier and Tank circuits. The RF signal from the antenna is coupled through RF cable W301 to a tap on L1. The tap is

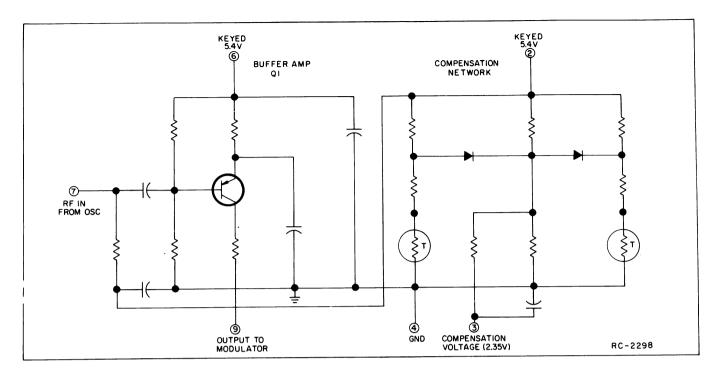


Figure 3 - Typical Compensator Circuit

positioned to provide the proper impedance match to the antenna. RF energy is coupled to the third coil (L3) through openings in the sides of the cans. RF is then coupled from a tap on L3 through Cl to the base of RF amplifier Ql. The output of Ql is developed across tuned circuit C2/Ll and is applied to the base of the mixer.

The output of the Compensator module is applied to L1 in Filter circuit A8.

MULTIPLIER & MIXER A301

A8-L1 is tuned to four times the crystal frequency. The Filter output is applied to Multiplier A3. The multiplier coil (A3-L1) is also tuned to four times the crystal frequency and is metered at H8 (Mult Test Point). Following the multiplier is Tank circuit A9. The tank circuit coil (A9-L1) is tuned to two times the multiplier output for a total multiplication of eight times. The output of the Tank circuit is direct-coupled to the emitter of the mixer transistor.

The RF signal from the RF amplifier is applied to the base of mixer Q2 and the low side injection voltage from the multiplier assembly is applied to the emitter. The resultant 20-MHz IF frequency is coupled through the mixer collector tank (L2 & C6) to Crystal Filter A303. The collector tank also provides impedance matching to the crystal filter.

CRYSTAL FILTERS A303 & A305

Filter A303 follows the Multiplier-Mixer stage, and its output is applied to the 1st IF amplifier module. Filter A305 follows the IF Amplifier module. The two Crystal Filters provide the major selectivity for the receiver. A303 provides a minimum of 40 dB stop-band attenuation, while A305 provides a minimum of 20 dB stop-band attenuation.

IF AMPS A304 & A306

An IF Amplifier module follows each of the crystal filters, and contain the resistor-matching networks for the filters. A typical IF amplifier circuit is shown in Figure 4.

Each of the IF Amplifier modules consists of three R-C coupled amplifier stages that are DC series-connected for reduced drain. The two IF modules provide a total gain of approximately 85 dB.

LIMITER A307 & DISCRIMINATOR A308

Limiter A307 consists of three R-C coupled limiter stages that are DC series connected for reduced drain. The Limiter module also provides some gain. The output of the Limiter is applied to the discriminator. A typical Limiter circuit is shown in Figure 5.

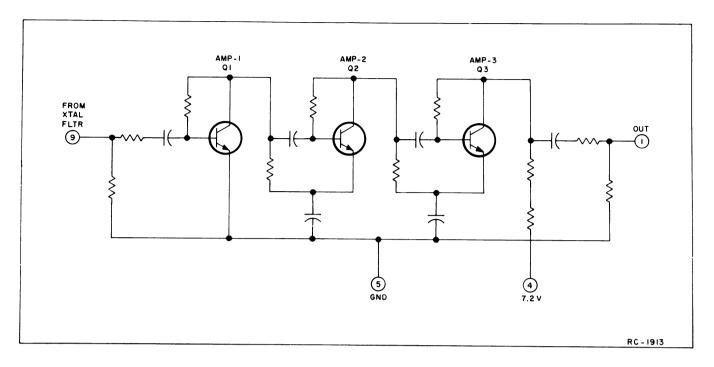


Figure 4 - Typical IF Amplifier Circuit

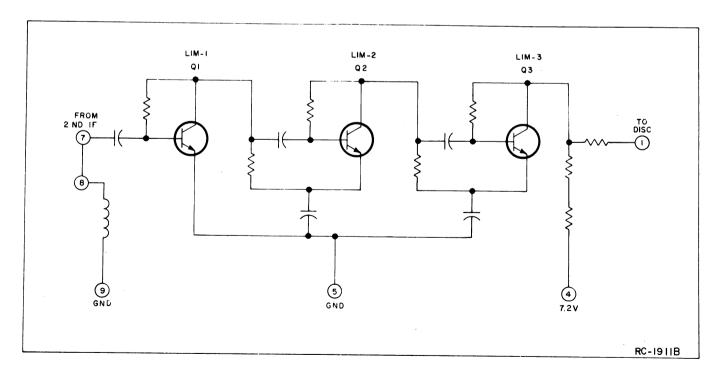


Figure 5 - Typical Limiter Circuit

The receiver uses a 20 MHz, fixed-tuned crystal discriminator (A308) to recover the audio from the IF signal. The Discriminator output is applied to the Audio Amplifier module.

AUDIO AMPLIFIER A309/A310

Audio and noise from the discriminator is applied to Audio Amplifier module A309 (A310 in Channel Guard applications). A typical audio amplifier circuit is shown in Figure 6.

Audio and noise is applied to the base of Q1. This stage operates as an emitter-follower for matching the impedance of the discriminator to the amplifier stage (Q2) and the VOLUME control. The output of Q1 connects from Pin 2 to the base of amplifier Q2 (Pin 4) through the VOLUME control. The output of Q1 is also applied to the input of the Squelch module.

Following amplifier Q2 is an active low-pass filter (Q3). Audio from the filter is connected from Pin 9 to the Audio PA module. In Audio Amplifier module A323, an active high-pass filter is added in series with the low-pass filter to provide the required tone frequency roll-off.

AUDIO PA A311

When the receiver is quieted by a signal, audio from the active filter is connected to Pin 1 of Audio PA module A311, and then to the base of amplifier Q1. Q1 feeds the audio signal to the base of Q2, which drives PA transistors Q4 and Q5. A typical audio PA circuit is shown in Figure 7.

PA transistors Q4 and Q5 operate as complementary emitter-followers, providing a 500 milliwatt output into an 8-ohm load. Audio from Pin 9 is coupled through capacitor C302 on the receiver board to the loudspeaker.

SQUELCH A312

Noise from Audio Amplifier A309/A310 operates the squelch circuit. A typical squelch circuit is shown in Figure 8.

When no carrier is present in the receiver, the noise output of active high-pass filter Q1 is coupled to the base of noise amplifier Q2 through SQUELCH control R708. R708 controls the gain of the noise amplifier.

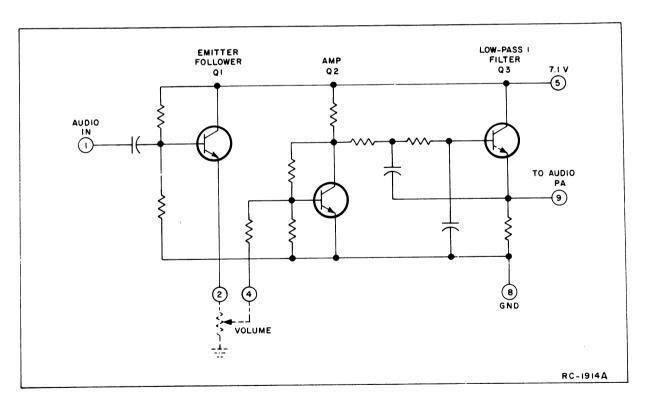


Figure 6 - Typical Audio Amplifier

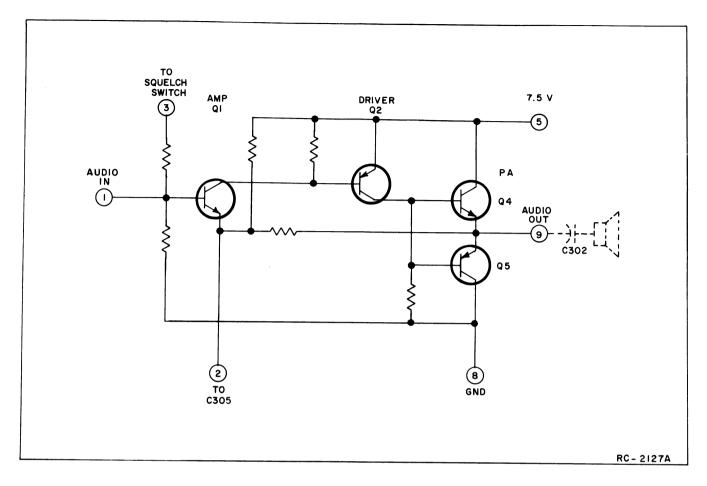


Figure 7 - Typical Audio PA Circuit

The output of noise amplifier Q2 is detected by diodes CR1 and CR2, and the resultant positive voltage turns off the PNP squelch switch Q3. In standard radios, the emitter of Q3 is connected to +7 Volts by means of a jumper from H1 to H2. When noise turns off Q3, its collector drops to ground potential. As the collector of Q3 is connected to the base of amplifier Q1 in the audio PA module, turning off Q3 also turns off Q1, keeping the audio PA turned off.

When the receiver is quieted by a signal, squelch switch Q3 turns on. This applies +7 Volts to the base of amplifier Q1 in the Audio PA module, turning the Audio

PA circuit on so that sound is heard at the speaker.

In tone decoder applications, the 7-Volt jumper from H1 to H2 is removed. The emitter of squelch switch Q3 is connected to 7.5 Volts by a DC switch on the decoder board.

An RF adaptor cable is available for connecting the receiver to a signal generator. Connecting the RF adaptor cable to J702 opens a set of contacts on the antenna strip line assembly. This disconnects the antenna and connects the receiver input to J702-1. Connect to chassis ground is made at J702-4.

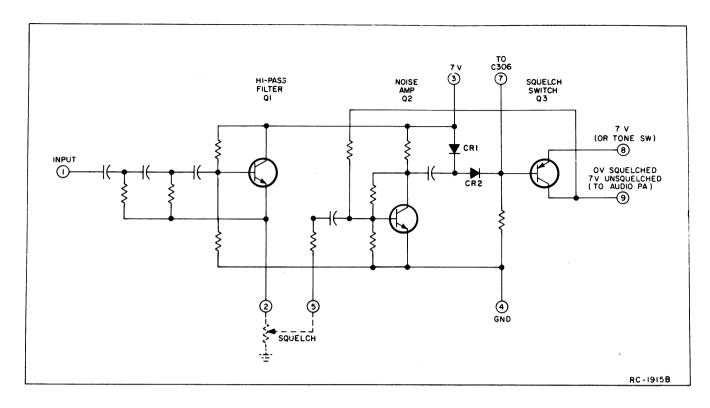


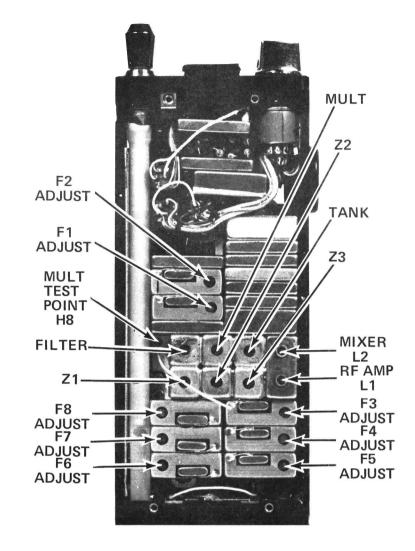
Figure 8 - Typical Squelch Circuit

GENERAL ELECTRIC COMPANY+ MOBILE COMMUNICATIONS DIVISION WORLD HEADQUARTERS+LYNCHBURG, VIRGINIA 24502 U.S.A.

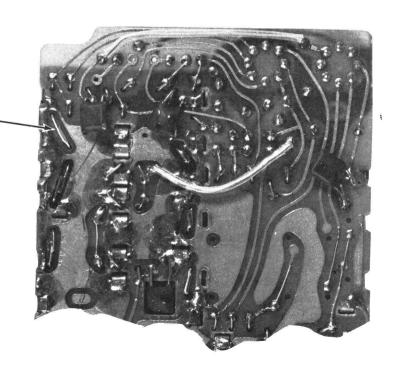


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COMPONENT SIDE



SOLDER SIDE



PIN 1 OF AUDIO AMP A309 (DISC OUTPUT)

RECEIVER ALIGNMENT

LBI4664

EQUIPMENT REQUIRED

- 1. A 20-MHz signal source (GE IF Generator Model 4EX9A10 or equivalent) and a 138-155 MHz source connected to Antenna Switch J702 by Receiver Test Cable 19C317633G1
- 2. GE Test Set Model 4EX3A10 or 4EX8K11 or voltmeter with equivalent sensitivity.
- 3. Distortion Analyzer or AC-VTVM.

PRELIMINARY CHECKS AND ADJUSTMENTS

- 1. In multi-frequency receivers where the maximum frequency spacing is less than one MHz, align the receiver of the Fl channel. Where the frequency spacing is more than one MHz, align the receiver on the highest frequency.
- 2. For frequencies in the low end of the band, set the slugs in Z1 thru Z3, RF AMP L1, and Tank L1 to the bottom of the coil form. Set Filter, Mult, and Mixer L2 slugs to the top of the coil form.

For frequencies near the high end of the band, set the slugs in Z1 thru Z3, Filter, Mixer L2, and Tank to the top of the coil form, set RF AMP L1 and Mult to the bottom of the coil form.

3. Connect the negative lead of the DC Test Set to the Mult Test Point (H8), and the positive lead to ground. Connect the Distortion Analyzer or AC-VTVM across the speaker leads.

ALIGNMENT PROCEDURE

Step No.	Tuning Control	Procedure
1	Mult	Apply an on-frequency signal to J702 and tune Mult for best quieting sensitivity on AC-VTVM.
2	Filter	Adjust Filter for best quieting sensitivity on AC-VTVM.
3	Mult Tank	De-tune Mult. Next, increase the on-frequency input signal and tune Tank for best quieting sensitivity on AC-VTVM.
4	Filter Mult	Adjust Filter and Mult for peak reading on meter connected to H8.
5	Z1, Z2, Z3, RF AMP L1, Mixer L2.	Adjust Z1, Z2, Z3, RF AMP L1, and Mixer L2 for best quieting sensitivity on AC-VTVM.
		FREQUENCY ADJUSTMENT
6		While applying an on-frequency signal to J702, loosely couple a 20-MHz signal to the Mixer. Adjust the Oscillator trimmer(s) for a zero beat frequency between the two signals.
		Alternate Method: Apply a strong 20 MHz signal to the Mixer. Measure the output of the Discriminator with a DC-VTVM at Pin 1 of A309/A310. Note the reading. Next, remove the 20-MHz signal and apply a strong onfrequency signal to J702. Then tune the oscillator trimmer(s) for the meter reading obtained at Pin 1 of A309/A310.

ALIGNMENT PROCEDURE

138—150.8 MHz RECEIVER MODELS 4ER59B10 & B12

TEST PROCEDURES

These Test Procedures are designed to help you to service a receiver that is operating --- but not properly. The problems encountered could be low power, poor sensitivity, distortion, and low gain. By following the sequence of test steps starting with Step 1, the defect can be quickly localized.

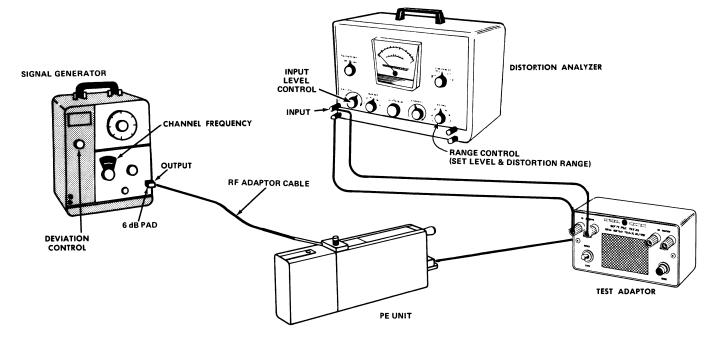
Once the defective stage is pin-pointed, refer to the "Service Check" listed to correct the problem. Additional corrective measures are included in the Troubleshooting Procedure. Before starting with the Receiver Test Procedures, be sure the receiver is tuned and aligned to the proper operating frequency.

TEST EQUIPMENT REQUIRED

- Distortion Analyzer similar to: Heath IM-12
- Signal Generator similar to: Measurements M-800
- 6-dB attenuation pad
- Test Adaptor Model 4EX12A10
- RF Adaptor Cable 19C317633G1

PRELIMINARY ADJUSTMENTS

- Connect the test equipment to the receiver as shown for all steps of the receiver Test Procedure.
- Turn the SQUELCH control fully clockwise for all steps of the Test Procedure.
- Turn on all of the equipment and let it warm up for 20 minutes.



STEP 1

AUDIO POWER OUTPUT AND DISTORTION TEST PROCEDURE

Measure Audio Power output as follows:

- A. Connect a 1,000-microvolt test signal modulated by 1,000 hertz ±3.3 kHz deviation to the Antenna Switch J702.
- B. Set the Volume Control for a 500 milliwatt output (2 volts RMS).
- . Make distortion measurements according to manufacturer's instructions. Reading should be less than 10% (5% is typical). If the receiver sensitivity is to be measured, leave all controls and equipment as they are.

SERVICE CHECK

If the distortion is more than 5%, or maximum audio output is less than 0.5 watt, make the following checks:

- D. Battery voltage---low voltage will cause distortion. (Refer to Receiver Schematic Diagram for voltages.)
- E. Audio Gain (Refer to Receiver Trouble-shooting Procedure).

STEP 2

USABLE SENSITIVITY (12 dB SINAD) TEST PROCEDURE

If STEP 1 checks out properly, measure the receiver sensitivity as follows:

- A. Apply a 1000-microvolt, on-frequency signal modulated by 1000 Hz with 3.3-kHz deviation to J702.
- B. Place the RANGE switch on the Distortion Analyzer in the 200 to 2000-Hz distortion range position (1000-Hz filter in the circuit). Tune the filter for minimum reading or null on the lowest possible scale (100%, 30%, etc.)
- C. Place the RANGE switch to the SET LEVEL position (filter out of the circuit) and adjust the input LEVEL control for a +2 dB reading on a mid range (30%).
- D. While reducing the signal generator output, switch the RANGE control from SET LEVEL to the distortion range until a 12-dB difference (+2 dB to -10 dB) is obtained between the SET LEVEL and distortion range positions (filter out and filter in).

- E. The 12-dB difference (Signal plus Noise and Distortion to noise plus distortion ratio) is the "usable" sensitivity level. The sensitivity should be less than rated 12 dB SINAD specification with an audio output of at least 250 milliwatts.
- F. Leave all controls as they are and all equipment connected if the Modulation Acceptance Bandwidth test is to be performed.

SERVICE CHECK

If the sensitivity level is more than rated 12 dB SINAD, check the alignment of the RF stages as directed in the Alignment Procedure, and make the gain measurements as shown on the Troubleshooting Procedure.

STEP 3

MODULATION ACCEPTANCE BANDWIDTH (IF BANDWIDTH)

TEST PROCEDURE

If STEPS 1 and 2 check out properly measure the bandwidth as follows:

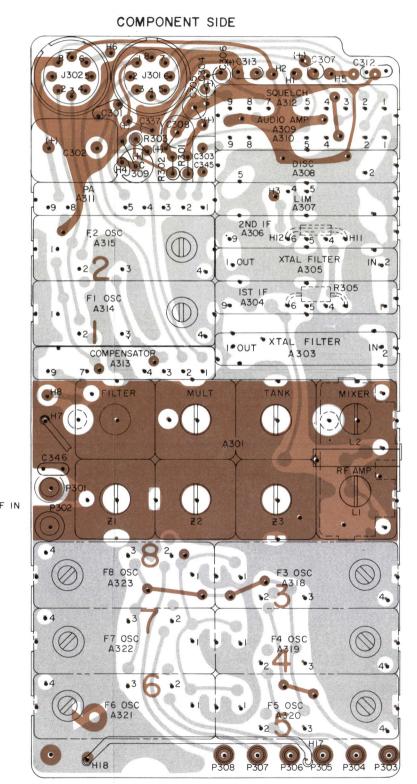
- A. Set the Signal Generator output for twice the microvolt reading obtained in the 12-dB SINAD measurement.
- B. Set the RANGE control on the Distortion Analyzer in the SET LEVEL position (1000-Hz filter out of the circuit), and adjust the input LEVEL control for a +2 dB reading on the 30% range.
- C. While increasing the deviation of the Signal Generator, switch the RANGE control from SET LEVEL to distortion range until a 12-dB difference is obtained between the SET LEVEL and distortion range readings (from +2 dB to -10 dB).
- D. The deviation control reading for the 12-dB difference is the Modulation Acceptance Bandwidth of the receiver. It should be more than ±7 kHz (but less than ±9 kHz).

SERVICE CHECK

If the Modulation Acceptance Bandwidth test does not indicate the proper width, make gain measurements as shown on the Receiver Troubleshooting Procedure.

10

	PIN	PIN 2	PIN 3	PIN 4	PIN 5	PIN 6	PIN 7	PIN 8
J30I	5.4V	AUDIO OUT	SWITCHED 7.5V	SQ ARM	VOL ARM	SQ HI	VOL HI	GND
J302		FREQ I	FREQ 2			7.5 V	TONE SWITCH	GND



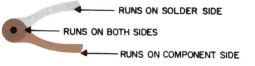
(19D416991, Rev. 6)

OUTLINE DIAGRAM

12

138—150.8 MHz RECEIVER MODELS 4ER59B10 & B12

(19D416896, Sh. 2, Rev. 7) (19D416896, Sh. 3, Rev. 6)



(19D416896, Sh. 2, Rev. 7)

N XTAL FILTER

MIXER!

4

A303

SOLDER SIDE

MULT

72

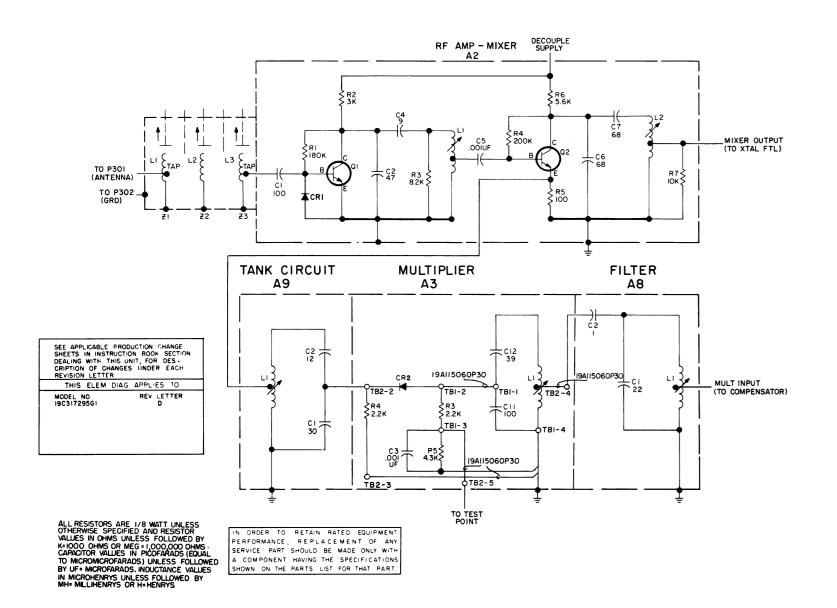
P302

0

4

F8 OSC A323

Issue 3

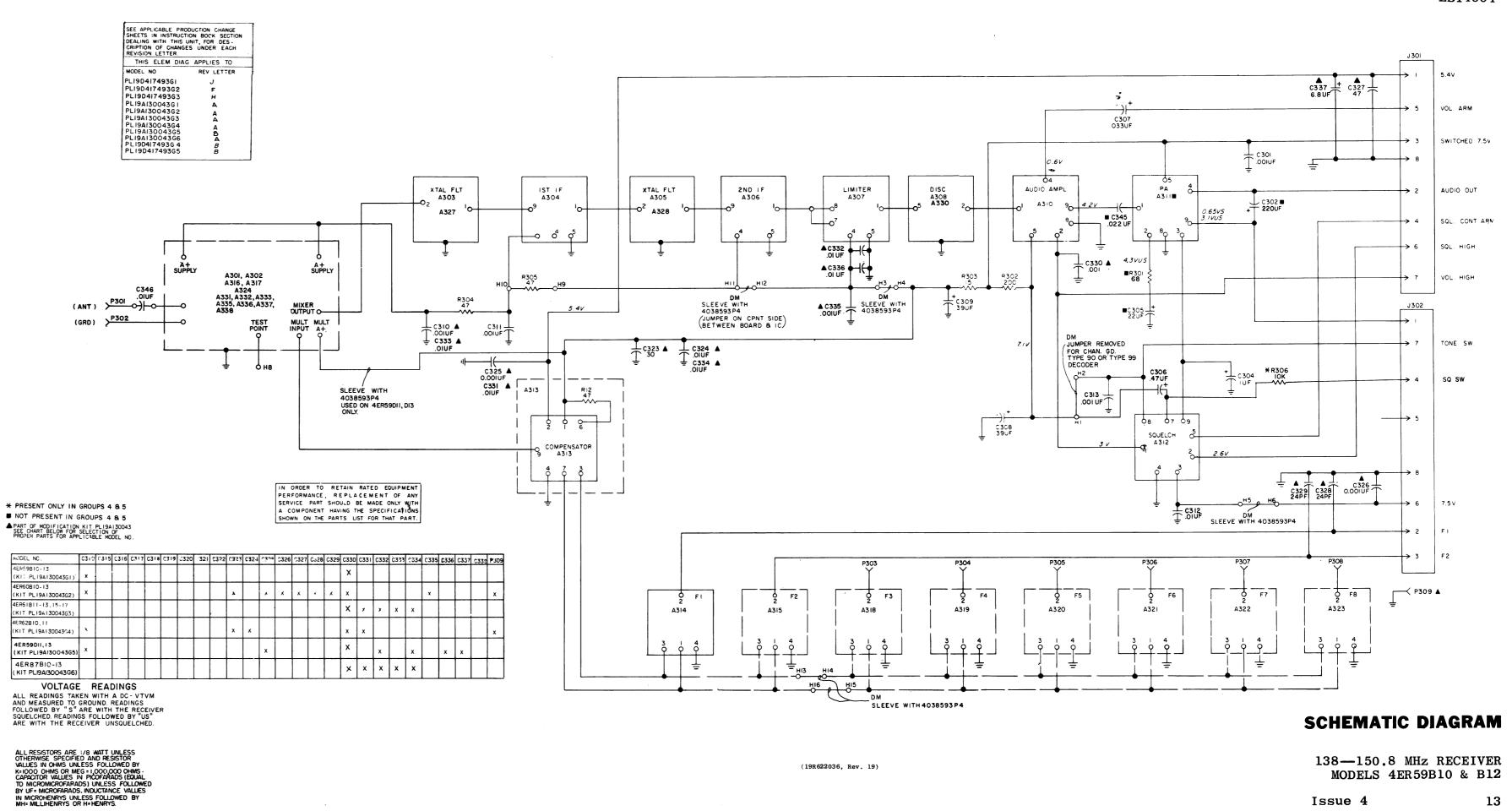


(19C320884, Rev. 5)

SCHEMATIC DIAGRAM

RECEIVER FRONT END (A301)

LBI4664



(19R622036, Rev. 19

138—150.8 MHz RECEIVER MODELS 4ER59B10 & B12

Issue 4

LBI4664

PARTS LIST

				1	•		- 1	1
		LBI4387E				L2	19B216441G14	Helical resonator. (Part of Z2). Includes:
		138-155 MHz RECEIVER MODEL 4ER59B10	Q1	19A116159P1	Silicon, NPN.		19C311727P1	Tuning slug.
		MODEL 4ER59B12	and Q2			L3	19B216441G15	Helical resonator. (Part of Z3). Includes:
					RESISTORS	1	19C311727P1	Tuning slug.
			Rl	3R151P184J	Composition: 180K ohms ±5%, 1/8 w.			HELICAL RESONATORS
SYMBOL	GE PART NO.	DESCRIPTION	R2	3R151P302J	Composition: 3K ohms ±5%, 1/8 w.	Z1		Consists of L1 and 19D413132P16 can.
			R3	3R151P822J	Composition: 8.2K ohms ±5%, 1/8 w.	Z2		Consists of L2 and 19D413132P3 can.
A301		FRONT END 19C317295G1	R4	3R151P204J 3R151P101J	Composition: 200K ohms ±5%, 1/8 w. Composition: 100 ohms ±5%, 1/8 w.	Z3		Consists of L3 and 19D413132P17 can.
		19631729301	R5 R6	3R151P562J	Composition: 5.6K ohms ±5%, 1/8 w.			RECEIVER BOARD
A2*		RF AMPLIFIER 19C327300G2	R7	3R151P103J	Composition: 10K ohms ±5%, 1/8 w.		1	19D417493G1 19D417493G4 VEHICLE REPEATER
		(Added by REV C)				A303*	19C304824G1	Crystal Filter.
			A3		MULTIPLIER 19C311873G4	A303+	15030462401	In REV B & earlier:
C1	19A116114P11064	Ceramic: 100 pf ±10%, 100 VDCW; temp coef					19C304516G3	Crystal Filter.
	10111611470050	-4200 PPM.						
C2 C4	19A116114P8053 19A116114P2030	Ceramic: 47 pf ±5%, 100 VDCW; temp coef -1500 PPM. Ceramic: 9 pf ±5%, 100 VDCW; temp coef -80 PPM.	C3	5495323P12 19A116114P2065	Ceramic: .001 µf +100% -20%, 75 VDCW. Ceramic: 100 pf ±5%, 100 VDCW; temp coef -80 PPM.	A304	19C311879G3	1st IF Amplifier.
C5	5495323P12	Ceramic: .001 µf +100% -20%, 75 VDCW.	C11 C12	19A116114P2050	Ceramic: 39 pf ±5%, 100 VDCW; temp coef -80 PPM.	A305	19C304824G1	Crystal Filter.
C6	19A116114P4059	Ceramic: 68 pf ±5%, 100 VDCW; temp coef -220 PPM.	1 012	15411011472000	Column of pr 100, 100 view, view of the transfer		10001107004	Ond IP Amplifion
and C7					DIODES AND RECTIFIERS	A306	19C311879G4	2nd IF Amplifier.
		DIODES AND RECTIFIERS	CR1*	19A116081P1	Silicon. Deleted by REV D.	A307	19C311876G4	Limiter.
CRl	19A116052P1	Silicon, hot carrier: Fwd. drop .350 volts max.	CR2*	19A116809P1	Silicon. Added by REV D.	A308	19C304504G3	Discriminator.
		TANDUGTTONS						
* 1	19B216950G1	Coil.	Ll	19B216296P1	Coil.	A309*	19C311878G2	Audio Amplifier. Deleted by REV G.
L1 L2	19B216948G1	Coil.						
	1							
						A310*	19C330341G1	Audio Amplifier. (Includes Tone Filter).
		TRANSISTORS	R3 and	3R151P222J	Composition: 2.2K ohms ±5%, 1/8 w.	""		In REV G:
Q1 and	19A116159P1	Silicon, NPN.	R4	2015104221	Composition: 4.3K ohms ±5%, 1/8 w.	-	19C311995G4	Audio Amplifier. (Includes Tone Filter).
Q2			R5	3R151P432J	Composition. 4.3k onus 15%, 176 ".	1		In REV F & earlier:
		RESISTORS			MISCELLANEOUS	ŀ	19C311995G2	Audio Amplifier. (Includes Tone Filter).
R1	3R151P184J	Composition: 180K ohms ±5%, 1/8 w.		19B200497P5	Tuning slug.	40114	19C311877G4	PA.
R2	3R151P302J	Composition: 3K ohms ±5%, 1/8 w.	A8		FILTER BOARD	A311*	19031187704	In REV E & earlier:
R3	3R151P822J	Composition: 8.2K ohms ±5%, 1/8 w.			19C320246G1		19C311877G2	PA.
R4	3R151P204J	Composition: 200K ohms ±5%, 1/8 w.				. [100000000000000000000000000000000000000	
R5	3R151P101J	Composition: 100 ohms ±5%, 1/8 w.	C1	19A116114P2041	Ceramic: 22 pf ±5%, 100 VDCW; temp coef -80 PPM.	A312*	19C330342G1	Squelch.
R6	3R151P562J 3R151P103J	Composition: 5.6K ohms ±5%, 1/8 w. Composition: 10K ohms ±5%, 1/8 w.	C2	19A116114P1	Ceramic: 1 pf $\pm 10\%$, 100 VDCW; temp coef 0 PPM.	1		In REV G & earlier:
R7	3815191033	Composition. Tok Onms 13%, 176 w.		İ			19C311880G4	Squelch.
A2*		RF AMPLIFIER 19C317445G2	Ll	19B216296P1	Coil.	A313	19C320061G1	Compensator.
		(Deleted by REV C)		100010001				
					MISCELLANEOUS	C201	5495323P12	Ceramic: .001 µf +100% -20%, 75 VDCW.
C1	19A116114P11064	Ceramic: 100 pf ±10%, 100 VDCW; temp coef		19B200497P5	Tuning slug.	C301 C302	19A116178P7	Tantalum: 220 µf ±20%, 6 VDCW.
		-4200 PPM.	A9		TANK BOARD	C302	19A116089P1	Ceramic: 0.1 uf ±20%, 50 VDCW, temp range -55
C2	19A116114P8053	Ceramic: 47 pf ±5%, 100 VDCW; temp coef -1500 PPM.		1	19C320245G1			+85°C. Deleted by REV G.
C4	19A116114P2030	Ceramic: 9 pf ±5%, 100 VDCW; temp coef -80 PPM.			CAPACITORS	C304	5491674P28	Tantalum: 1.0 μ f $\pm 20\%$, 25 VDCW; sim to Spragu Type 162D.
C5	5495323P12	Ceramic: .001 μf +100% -20%, 75 VDCW.	C1	19A116114P2045	Ceramic: 30 pf ±5%, 100 VDCW; temp coef -80 PPM.	C305	5491674P35	Tantalum: 22 µf ±20%, 4 VDCW; sim to Sprague
C6 and	19A116114P4059	Ceramic: 68 pf ±5%, 100 VDCW; temp coef -220 PPM.	C2	19A116114P2033	Ceramic: 12 pf ±5%, 100 VDCW; temp coef -80 PPM.	6206	5491674P27	Type 162D. Tantalum: .47 μf ±20%, 35 VDCW; sim to Spragu
C7						C306	34910/472/	Type 162D.
		DIODES AND RECTIFIERS	L1	19A129340Pl	Coil.	C307	5491674P31	Tantalum: .033 μ f $\pm 20\%$, 35 VDCW; sim to Sprag Type 162D.
CR1*	19A116052P1	Silicon, fast recovery, 225 mA, 50 PIV. Added by REV B.			MISCELLANEOUS	C308	5491674P30	Tantalum: 39 µf ±20%, 10 VDCW; sim to Sprague
	1	INDUCTORS		10000040775		and C309		Type 162D.
	19B216950G1	Coil.		198200497P5	Tuning slug.	C311	5495323P12	Ceramic: .001 µf +100% -20%, 75 VDCW.
L1 L2	19B216950G1 19B216948G1	Coil.		1				1
1.2	10021004001		Ll	19B216441G13	Helical resonator. (Part of $Z1$). Includes:			
		1		19C311727P1	Tuning slug.			1
1	I		1 1	I	1	l i	1	1

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DESCRIPTION

GE PART NO

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*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.

	Н			
al resonator. (Part of Z2). Includes:	Н	C312*	19A116192Pl	Ceramic: 0.01 µf ±20%, 50 VDCW; sim to Erie
z slug.	Ш			8121 SPECIAL.
al resonator. (Part of Z3). Includes:	П			In REV A & earlier:
g slug.	$ \ $		5495323P12	Ceramic: .001 µf +100% -20%, 75 VDCW.
-	П	C313	5495323P12	Ceramic: .001 µf +100% -20%, 75 VDCW.
HELICAL RESONATORS	П	C314*	5495323P12	Ceramic: .001 µf +100% -20%, 75 VDCW. Deleted by REV D.
sts of L1 and 19D413132P16 can. sts of L2 and 19D413132P3 can.	П	C345*	19A116192P6	Ceramic: 0.022 µf ±20%, 50 VDCW; sim to Erie 8131-M050-W5R-223M. Added by REV E.
sts of L2 and 19D413132P3 can.	П	C346*	19A116192P1	Ceramic: 0.01 µf ±20%, 50 VDCW; sim to Erie
	П			8121 SPECIAL. Added by REV J.
RECEIVER BOARD 19D417493G1	П			JACKS AND RECEPTACLES
19D417493G4 VEHICLE REPEATER		J301	19A116122P1	Feed-thru: sim to Warren Co 1-B-2994-4.
al Filter.	П	and J302		
/ B & earlier:	П			PLUGS
al Filter.		P301 thru	19A115834P4	Contact, electrical: sim to AMP 2-332070-9.
F Amplifier.		P308		RESISTORS
al Filter.		R301*	3k151P680J	Composition: 68 ohms ±5%, 1/8 w.
		2001-		In REV A-C:
F Amplifier.			3R151P101J	Composition: 100 ohms ±5%, 1/8 w.
er.				Earlier than REV A:
			3R151P470J	Composition: 47 ohms ±5%, 1/8 w.
iminator.		R302	3R151P201J	Composition: 200 ohms ±5%, 1/8 w.
Amplifier. Deleted by REV G.		R303*	3R151P150J	Composition: 15 ohms ±5%, 1/8 w. Deleted by REV K.
<u> </u>	1	R304	3R151P470J	Composition: 47 ohms ±5%, 1/8 w.
		and R305		
			1	
Amplifian (Includes Tone Pilian)		P207+	19412456401	Metal film: 15 ohms ±5%, 1/4 w. Added by REV K.
Amplifier. (Includes Tone Filter).		R307*	19A134564P1	TO COME TO STATE OF THE PARTY O
V G: Amplifier. (Includes Tone Filter).				MISCELLANEOUS
W F & earlier:			19A127110P1	Screw, phillips: No. 1-64 x 5/32. (Secures A301).
Amplifier. (Includes Tone Filter).	ı		NP258043	Nameplate. (FCC).
<u> </u>			19C311491P6	Can, vertical. (Used with A310 & A312).
			19B216316P1	Insulator. (Used with J301, J302).
V E & earlier:				
				RECEIVER KIT 19A1 3004 3G3
ch.				
V G & earlier:				
ch.		C330*	5495323P12	Ceramic: .001 µf +100% -20%, 75 VDCW. Added by REV A.
		C331	19A116192P1	Ceramic: 0.01 µf ±20%, 50 VDCW; sim to Erie
nsator.		thru C334		8121 SPECIAL.
CAPACITORS				ASSOCIATED ASSEMBLIES
ic: .001 μf +100% -20%, 75 VDCW.				INCOMINE UNDERSON
lum: 220 µf ±20%, 6 VDCW.				OSCILLATORS
ic: 0.1 μf $\pm20\%$, 50 VDCW, temp range -55 to . Deleted by REV G.		}		NOTE: When reordering, give GE Part Number and specify exact frequency needed.
lum: 1.0 μf ±20%, 25 VDCW; sim to Sprague		A314	4EG28A15	Oscillator Module. 138-155 MHz. Fx = Fo - 20
162D. lum: 22 μf ±20%, 4 VDCW; sim to Sprague		and A315	TEGESATO	8
162D.			45000435	Oscillator Module. 138-155 MHz. $Fx = Fo - 20$
lum: .47 μ f $\pm 20\%$, 35 VDCW; sim to Sprague 162D.		A318 thru A323	4EG28A15	OSCIIIA LUI MUULIE. 130-133 MILZ. FA = 10 - 20
lum: .033 μ f $\pm 20\%$, 35 VDCW; sim to Sprague 162D.				
lum: 39 µf ±20%, 10 VDCW; sim to Sprague				
162D.				
nic: .001 μf +100% -20%, 75 VDCW.			1	
			1	
	J		· · ·	<u> </u>

DESCRIPTION

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PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

- REV. A Receiver Models 4ER59Bl0 & 12
 To improve Squelch action.
 Changed A312 and A305.
- REV. A Receiver Board 19D417493G1 To improve audio sensitivity. Changed R301,
- REV. A Receiver Front End 19C317295G1
- To improve spurious response.

 Deleted R2 and R6. Added R9, R10 and Shield.
- REV. B Receiver Board 19D417493G1 To improve Squelch operation. Changed C312.
- REV. C To improve producibility. Changed A303.
- REV. D To improve audio stability. Deleted C314 and Changed R301.
- REV. E To improve audio frequency response.
 Added C345.
- REV. F To improve audio. Changed A313.
- REV. B Receiver Front End 19C317295G1
 To add protection to RF and Mixer transistors. Added CR1.
- REV. C To ease assembly, troubleshooting and repair. Changed A2.
- REV. G Receiver Board 19D417493G1

 - To delete non-Channel Guard receiver boards.
 Added A310 and C345.
 Deleted drawing callouts MA309 and circle (•) in front of A312.
 Deleted drawing callouts C303, .1 µf and circle (•) in front of
- Deleted NOTE: •Used with Channel Guard receivers.
- REV. A Receiver Kit 19A130043G3
- To improve IF filtering. Added C330.
- REV. H Receiver Board 19D417493G1
 This revision is "VOID".
- REV. J To provide DC isolation of relay receive contacts from antenna circuit.
 Added C346.
- REV. D Receiver Front End 19031729561
 To replace single source diode with a multi-source diode.
 Deleted CR1.
 Added CR2 and R8.

QUICK CHECKS

SYMPTON	PROCEDURE
No Audio	1. Check audio waveform at the top of the Volume Control (see Step 2).
	2. If audio is present, check voltage read- ings of Audio and Squelch modules (see Schematic Diagram).
	3. If audio is not present, check gain and current readings of Front End and IF modules (see Steps 1 & 3).
Poor Sensi- tivity	1. Measure the injection voltage for a minimum level of 30 millivolts. If the reading is low, check the output of the Oscillator and Compensator modules with an RF voltmeter.
	 Measure the gain of the Mixer stage (see Step 3). If low, measure the gain of the RF amplifier and IF modules.
Improper Squelch Operation	 Check the noise waveform at the input to the Squelch module and at Squelch Control high (see Step 2).
	 Measure the DC voltages for the Squelch module (squelched and unsquelched).

SYMPTON	PROCEDURE
No Audio	1. Check audio waveform at the top of the Volume Control (see Step 2).
	2. If audio is present, check voltage readings of Audio and Squelch modules (see Schematic Diagram).
	3. If audio is not present, check gain and current readings of Front End and IF modules (see Steps 1 & 3).
Poor Sensi- tivity	1. Measure the injection voltage for a minimum level of 30 millivolts. If the reading is low, check the output of the Oscillator and Compensator modules with an RF voltmeter.
	2. Measure the gain of the Mixer stage (see Step 3). If low, measure the gain of the RF amplifier and IF modules.
Improper Squelch Operation	1. Check the noise waveform at the input to the Squelch module and at Squelch Control high (see Step 2).
	2. Measure the DC voltages for the Squelch module (squelched and unsquelched).

STEP 3-RF GAIN CHECKS (STEPS Q THRU U) 7 V 0.6-1.0 MA 0.6 MA SQUELCHED 2 ND IF 42 dB RF probe and Test Amplifier Model 4EX16AlO connected to GE Test Set Model 4EX3AlO, or an RF voltmeter. AUDIO PA A3II AUDIO AMP A309/A310 A306 A304 A signal generator (M-800 or equivalent) connected to P301 (High) and P302 (Low). 7. V I M A 1. Switch the Test Set to the Test 1 position and the Test Amplifier 7.3 V 1.1 MA SQUELCH A312 VOLUME 2. Connect the RF probe across the input of the stage to be measured as shown on the diagram. Increase the signal generator output to obtain a reference reading on Test Set 4EX3AlO. Note the Test Set reading and the dB reading on the generator (dBl). 3. Connect the RF probe to the output of the stage to be measured as shown on the diagram. Decrease the generator output until the Test Set reference reading in Step 2 is obtained. Note the dB 0.5 MA 4. Subtract the dB1 reading from the dB2 reading and check the results OSC A3I4/A3I5 1. With no signal in, connect the RF probe to the output of the 2nd IF module. Increase the signal generator output until the Test Set reading increases by approximately 0.2 volt. Note Test Set STEP 2 -SCOPE SETTINGS PEAK-TO-PEAK SIGNAL Connect the probe to the input of the 2nd IF module. Increase the signal generator until the Test Set reference reading is obtained, and note the dB reading (dBl). AUDIO & SQUELCH WAVEFORMS 7.5 V 2.8 MA MODULE CURRENT CHECKS READINGS (STEPS L THRU P) (STEPS A THRU K) STANDARD SIGNAL 3. Now subtract dB2 from dB1 to obtain the gain of the 2nd IF STEP 2 - AUDIO & SQUELCH WAVEFORMS STEP 1 - MODULE CURRENT CHECKS These current readings provide a method of checking the operation of each Integrated Circuit module using a milliammeter (Triplett 630 or equivalent). EQUIPMENT REQUIRED: NOISE WAVEFORM • Oscilloscope connected between the points shown and 1. Unsolder the + lead as shown in the Diagram of the module to be checked. • Signal Generator (Measurements M-800 or equivalent). Connect the milliammeter in series with the + lead, and check for the indicated current drain and supply voltage. No current drain indicates that the module should be

INJECTION VOLTAGE TEST POINT

(RC-2150) (19D416991, Rev. 6) (19D416896, Sh. 2, Rev. 7)

LIMITER CHECK

PROCEDURE FOR 2ND IF:

STEP 3 - RF GAIN CHECKS

PROCEDURE FOR MIXER & 1ST IF:

to the X50 position.

reading on the generator (dB2).

and signal generator reading (dB2).

with the typical gains shown on the diagram.

EQUIPMENT REQUIRED:

The Limiter module limits on noise so tha the gain of the circuit cannot be measured. The following procedure provides a check to determine if the module is limiting.

- Switch the Test Amplifier to the X1 position and the Test Set to the Test 1 position. Then connect the RF probe to the output of the Limiter module and check for a reading of approximately 0.4
- Increase the signal generator output. There should be no appreci-able increase in the limiter output meter reading.

--- CAUTION ----When checking the current of Audio PA module A311, do not short Pin 4 to ground or to + (Pin 5). To do so will destroy the Audio PA module.

PRELIMINARY STEPS:

- 1. Apply a standard signal to P301. A standard signal is 1000 microvolts on the receiver frequency modulated by one kHz with 3.3-kHz deviation.
- 2. Set the Volume control for 0.5-watt output.

TROUBLESHOOTING PROCEDURE

138—150.8 MHz RECEIVER MODELS 4ER59B10 & B12